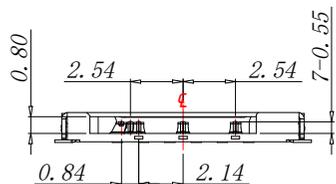
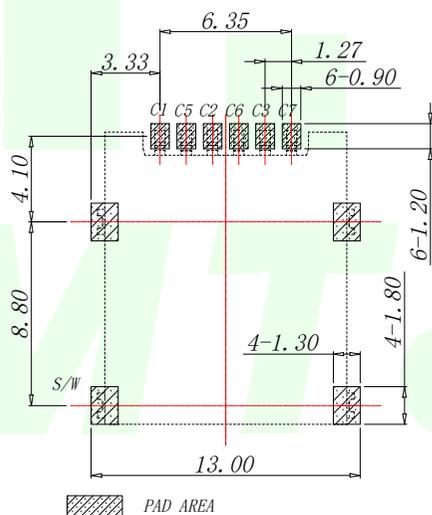


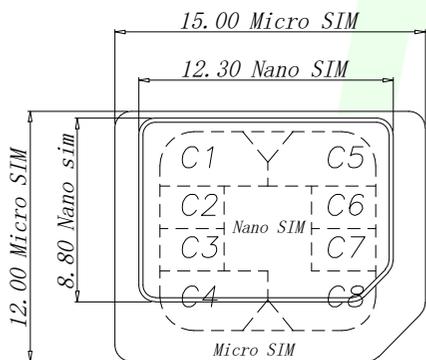
- NOTES:
- MATERIAL:
 - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal: Copper Alloy, T=0.12mm.
 - Shell: Stainless Steel, T=0.20mm.
 - FINISH:
 - Terminal: Plated Gold on The Contact Area and Solder Tails
 - Peg: Plated Gold on the Solder Tails.
 - SPECIALITY:
 - Rated current: 0.5A
 - Rated voltage: 50V
 - Contact Resistance: 80mΩMAX
 - Insulation Resistance: 100MΩMIN 100V DC
 - Dielectric withstanding voltage: 100V AC.
 - Solder ability: 245±5° C, 5±0.5s.
 - Operating condition: Temperature: -40° C~+85° C Humidity: 80% R.H MAX



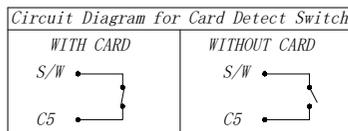
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
S/W	Switch Pin



NO.	PART NAME	Q'TY	DESCRIPTION	NOTE
③	TERMINAL	6	C5210-EH, T=0.12	G/F PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.15	AU/Ni PLATING

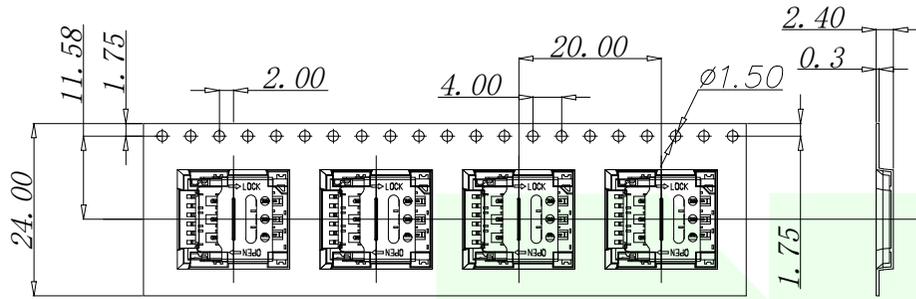


RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



GENERAL TOLERANCES UNLESS SPECIFIED		深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd	
X.±0.50	X.°±2°	PART NO.	TITLE: 7pin 1.4h higne nano sim card conn
.X±0.20	.X.°±1°	HMT-NANO-1306	
.XX±0.10		DESIGN: James	CUSTOMER
MANUFACTURE DWG		CHED: Talen	SIZE: A4
		APPD: Sophia	UNITS: MM
			SCALE: N:A
			SHEET: 1/2

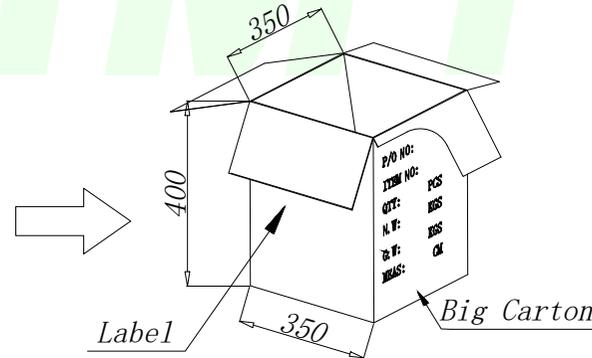
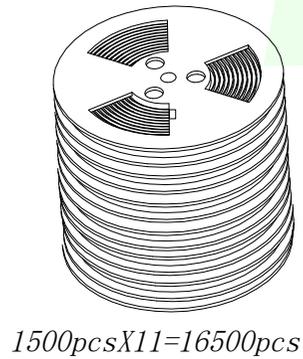
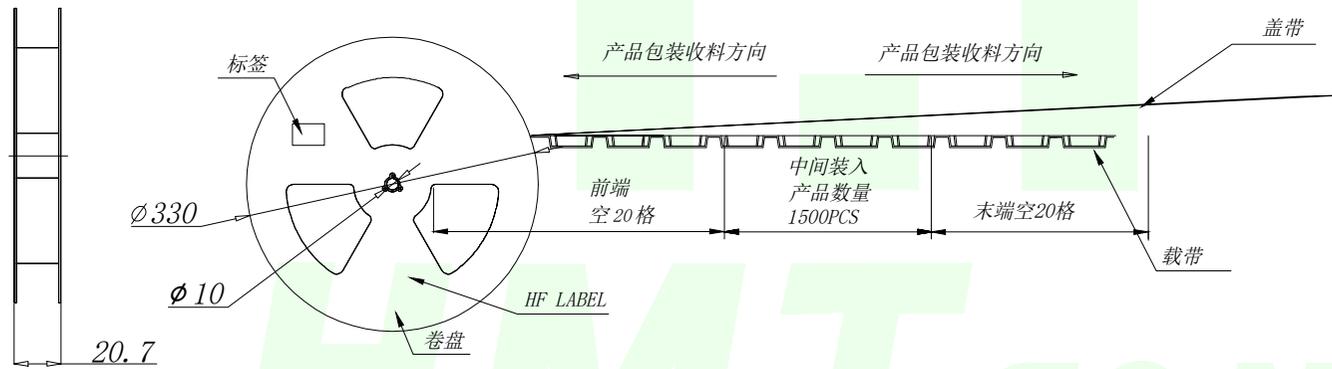
图示(一) 载带



NOTES:

- 1, 每盘包装 1500PCS 产品. 包装要求如图示(二)
- 2, 每箱包装数量 16500PCS. 纸箱外则以胶带封口成(工)字型.
- 3, 上载带剥离不速度 :300mm/minutes.
- 4, 卷带封合力小于 100G.

图示(二) 圆盘包装



GENERAL TOLERANCES UNLESS SPECIFIED		 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd	
X.±0.50	X.°±2°	PART NO. HMT-NANO-1306	TITLE: 7pin 1.4h higne nano sim card conn
.X±0.20	.X°±1°	DESIGN: James	CUSTOMER
.XX±0.10		CHED: Talen	
MANUFACTURE DWG		APPD: Sophia	UNITS MM
			SCALE N:A
			SHEET 2/2